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--Guide rails for guiding a band-form member such as a film carrier tape in a semiconductor manufacturing apparatus. The guide rails include a pair of rail main bodies with a plurality of guide assemblies provided on the upper surfaces of the rail main bodies so that the guide assemblies partially guide the upper surface of the band-form member.--

IN THE CLAIMS:

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Please cancel claims 1 and 2 without prejudice.

Please add new claims 3-7 as follows:

1 3. Guide rails for conveying a band-form member comprising a pair of guide rails that are disposed facing each other so as to guide both sides of a band-form member, wherein said guide rails are comprised of rail main bodies and a plurality of guide members provided on said pair of rail main bodies, each of said guide members comprising a cylindrical member provided on said rail main bodies of a height greater than a thickness of said band-form member and a disk provided on said cylindrical member having a diameter greater than that of the cylindrical member.

2 4. The guide rails according to claim 3, wherein said plurality of guide members are provided on said rail main bodies at fixed intervals in a conveying direction of said band-form member so as to guide said band-form member in a width direction thereof.

3 5. The guide rails according to claim 4, wherein said disk is rotatably coupled to said cylindrical member.

4 6. The guide rails according to claim 5, wherein said cylindrical members are spaced apart in a transverse direction to said guide rails an amount equal to a width of the band-form member.

5 7. The guide rails according to claim 6, wherein said rotatable coupling between said disk and said cylinder comprises a pin provided on a top surface of said cylinder and a hole in a center of said disk which is rotatably fitted on said pin--